

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NOBUKAZU MATSUDO	06/10/2019
KOJI KAWAGUCHI	06/10/2019
RECEIVING PARTY DATA	
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Postal Code:	213-0012
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16473525
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SIGNATURE:	/DRC/
DATE SIGNED:	06/02/2021
Total Attachments: 1	
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U.S. ASSIGNMENT

(Insert ASSIGNEE's Name(s) Address(es))

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
UPCON Corporation of KSP East Bldg. 611, 3-2-1, Sakado, Takatsu-ku, Kawasaki-shi,
Kanagawa 213-0012 JAPAN

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:

(Title of Invention)

METHOD FOR CORRECTING CONCRETE PLATE TILTING ON SUBSIDED GROUND

(*If the assignment is being filed after the filing of the application, this section must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

June 25, 2019
* filed on _____, Serial No. 16/473,525

(Kratz, Quintos & Hanson, LLP is hereby authorized to insert the serial code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

	<u>Nobukazu MATSUDO</u>	<u>6/10/2019</u>
(Signature)	(Type Name)	(Date)
	<u>Koji KAWAGUCHI</u>	<u>6/10/2019</u>
(Signature)	(Type Name)	(Date)
_____	_____	_____
(Signature)	(Type Name)	(Date)
_____	_____	_____
(Signature)	(Type Name)	(Date)
_____	_____	_____
(Signature)	(Type Name)	(Date)